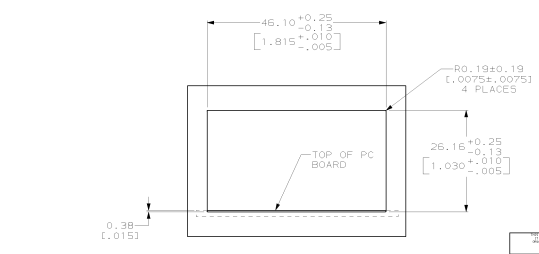


PC BOARD LAYOUT VIEWED FROM COMPONENT SIDE
 SCALE 2:1



SUGGESTED PANEL CUTOUT DIMENSIONS
 SCALE 2:1

MATERIAL:
 HOUSING - PCT POLYESTER, BLACK, UL94V-0, OVERMOLDED TERMINAL ARRAY - PBT, BROWN.
 TERMINALS - 0.33 [0.013] THICK PHOS BRONZE PLATED WITH 1.27µm [0.00050] MINIMUM THICK HARD GOLD IN LOCALIZED AREA AND 3.81µm [0.00150] MINIMUM THICK TIN-LEAD IN SOLDER AREA OVER 1.27µm [0.00050] MINIMUM THICK NICKEL UNDERPLATE.
 SHIELD - 0.25 [0.010] THICK COPPER ALLOY PLATED WITH 2.03µm [0.00080] MINIMUM TIN-LEAD OVER 2.54µm [0.00100] MINIMUM COPPER.

JACK CAVITY CONFORMS TO FCC RULES AND REGULATIONS, PART 68 SUBPART F.

MILITARY STANDARD DRAWING		REV	DATE	DESCRIPTION	BY	CHK
MIL-STD-883C		AA	22			
PART NUMBER		569261-1				
MANUFACTURER		AMP Incorporated Harrisburg, PA 17105-3608				
TITLE		STACKED MODULAR JACK ASSEMBLY, 2x3 PORT, 8 POSITION, SHIELDED, PANEL GROUND, CATEGORY 5				
PARTIAL		REV	DATE	DESCRIPTION	BY	CHK
PARTIAL						
CUSTOMER DRAWING		A1100779 C-569261				